

# SKM200GB12E4



SEMITRANS® 3

## IGBT4 Modules

### SKM200GB12E4

#### Features

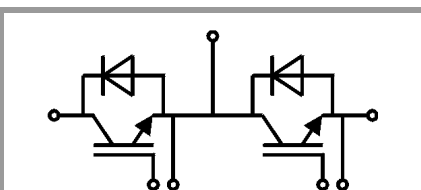
- IGBT4 = 4. generation medium fast trench IGBT (Infineon)
- CAL4 = Soft switching 4. generation CAL-diode
- Isolated copper baseplate using DBC technology (Direct Bonded Copper)
- Increased power cycling capability
- With integrated gate resistor
- For higher switching frequencies up to 12kHz
- UL recognized, file no. E63532

#### Typical Applications\*

- AC inverter drives
- UPS

#### Remarks

- Case temperature limited to  $T_c = 125^\circ\text{C}$  max.
- Recommended  $T_{op} = -40 \dots +150^\circ\text{C}$
- Product reliability results valid for  $T_j = 150^\circ\text{C}$



GB

#### Absolute Maximum Ratings

Symbol	Conditions	Values	Unit	
<b>IGBT</b>				
$V_{CES}$	$T_j = 25^\circ\text{C}$	1200	V	
$I_C$	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	313	A
		$T_c = 80^\circ\text{C}$	241	A
$I_{Cnom}$		200	A	
$I_{CRM}$	$I_{CRM} = 3 \times I_{Cnom}$	600	A	
$V_{GES}$		-20 ... 20	V	
$t_{psc}$	$V_{CC} = 800\text{ V}$	10	$\mu\text{s}$	
	$V_{GE} \leq 15\text{ V}$			
	$V_{CES} \leq 1200\text{ V}$			
$T_j$		-40 ... 175	$^\circ\text{C}$	
<b>Inverse diode</b>				
$I_F$	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	229	A
		$T_c = 80^\circ\text{C}$	172	A
$I_{Fnom}$		200	A	
$I_{FRM}$	$I_{FRM} = 3 \times I_{Fnom}$	600	A	
$I_{FSM}$	$t_p = 10\text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$	990	A	
$T_j$		-40 ... 175	$^\circ\text{C}$	
<b>Module</b>				
$I_{t(RMS)}$	$T_{terminal} = 80^\circ\text{C}$	500	A	
$T_{stg}$		-40 ... 125	$^\circ\text{C}$	
$V_{isol}$	AC sinus 50 Hz, $t = 1\text{ min}$	4000	V	

#### Characteristics

Symbol	Conditions	min.	typ.	max.	Unit
<b>IGBT</b>					
$V_{CE(sat)}$	$I_C = 200\text{ A}$ $V_{GE} = 15\text{ V}$ chipelevel	$T_j = 25^\circ\text{C}$	1.80	2.05	V
		$T_j = 150^\circ\text{C}$	2.20	2.40	V
$V_{CE0}$	chipelevel	$T_j = 25^\circ\text{C}$	0.8	0.9	V
		$T_j = 150^\circ\text{C}$	0.7	0.8	V
$r_{CE}$	$V_{GE} = 15\text{ V}$ chipelevel	$T_j = 25^\circ\text{C}$	5.00	5.75	$\text{m}\Omega$
		$T_j = 150^\circ\text{C}$	7.50	8.00	$\text{m}\Omega$
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 7.6\text{ mA}$	5	5.8	6.5	V
$I_{CES}$	$V_{GE} = 0\text{ V}$ $V_{CE} = 1200\text{ V}$	$T_j = 25^\circ\text{C}$		2.7	$\text{mA}$
		$T_j = 150^\circ\text{C}$			$\text{mA}$
$C_{ies}$	$V_{CE} = 25\text{ V}$		12.3		nF
$C_{oes}$	$V_{GE} = 0\text{ V}$		0.81		nF
$C_{res}$			0.69		nF
$Q_G$	$V_{GE} = -8\text{ V} \dots +15\text{ V}$		1130		nC
$R_{Gint}$	$T_j = 25^\circ\text{C}$		3.8		$\Omega$
$t_{d(on)}$	$V_{CC} = 600\text{ V}$	$T_j = 150^\circ\text{C}$	204		ns
$t_r$	$I_C = 200\text{ A}$ $V_{GE} = \pm 15\text{ V}$	$T_j = 150^\circ\text{C}$	40		ns
		$T_j = 150^\circ\text{C}$	21		mJ
$E_{on}$	$R_{Gon} = 1\ \Omega$	$T_j = 150^\circ\text{C}$			mJ
$t_{d(off)}$	$R_{Goff} = 1\ \Omega$	$T_j = 150^\circ\text{C}$	490		ns
$t_f$	$di/dt_{on} = 5500\text{ A}/\mu\text{s}$ $di/dt_{off} = 2300\text{ A}/\mu\text{s}$	$T_j = 150^\circ\text{C}$	107		ns
		$T_j = 150^\circ\text{C}$	27		mJ
$E_{off}$		$T_j = 150^\circ\text{C}$			mJ
$R_{th(j-c)}$	per IGBT			0.14	K/W



**SEMITRANS® 3**

## IGBT4 Modules

### SKM200GB12E4

#### Features

- IGBT4 = 4. generation medium fast trench IGBT (Infineon)
- CAL4 = Soft switching 4. generation CAL-diode
- Isolated copper baseplate using DBC technology (Direct Bonded Copper)
- Increased power cycling capability
- With integrated gate resistor
- For higher switching frequencies up to 12kHz
- UL recognized, file no. E63532

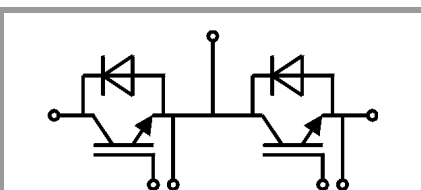
#### Typical Applications\*

- AC inverter drives
- UPS

#### Remarks

- Case temperature limited to  $T_C = 125^\circ\text{C}$  max.
- Recommended  $T_{op} = -40 \dots +150^\circ\text{C}$
- Product reliability results valid for  $T_j = 150^\circ\text{C}$

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
<b>Inverse diode</b>						
$V_F = V_{EC}$	$I_F = 200\text{ A}$ $V_{GE} = 0\text{ V}$ chipelevel	$T_j = 25^\circ\text{C}$		2.20	2.52	V
		$T_j = 150^\circ\text{C}$		2.15	2.47	V
$V_{F0}$	chipelevel	$T_j = 25^\circ\text{C}$		1.3	1.5	V
		$T_j = 150^\circ\text{C}$		0.9	1.1	V
$r_F$	chipelevel	$T_j = 25^\circ\text{C}$		4.5	5.1	m $\Omega$
		$T_j = 150^\circ\text{C}$		6.3	6.8	m $\Omega$
$I_{RRM}$	$I_F = 200\text{ A}$	$T_j = 150^\circ\text{C}$		174		A
$Q_{rr}$	$di/dt_{off} = 4450\text{ A}/\mu\text{s}$	$T_j = 150^\circ\text{C}$		33		$\mu\text{C}$
$E_{rr}$	$V_{GE} = \pm 15\text{ V}$ $V_{CC} = 600\text{ V}$	$T_j = 150^\circ\text{C}$		13		mJ
$R_{th(j-c)}$	per diode				0.26	K/W
<b>Module</b>						
$L_{CE}$				15	20	nH
$R_{CC'+EE'}$	terminal-chip	$T_C = 25^\circ\text{C}$		0.25		m $\Omega$
		$T_C = 125^\circ\text{C}$		0.5		m $\Omega$
$R_{th(c-s)}$	per module			0.02	0.038	K/W
$M_s$	to heat sink M6			3	5	Nm
$M_t$		to terminals M6		2.5	5	Nm
						Nm
$w$					325	g



**GB**

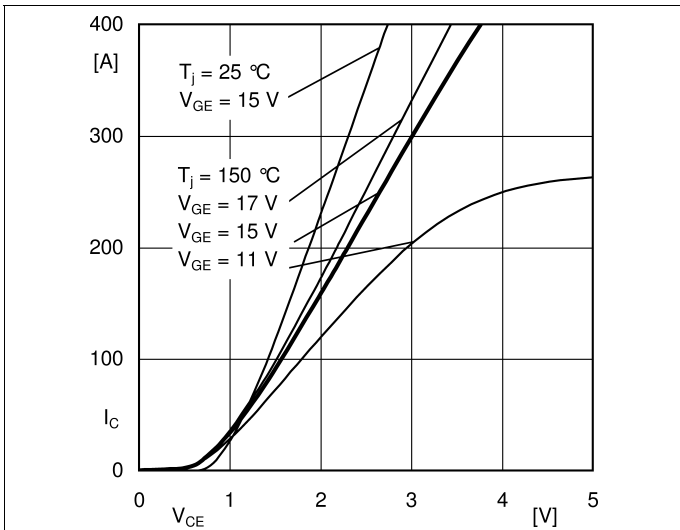


Fig. 1: Typ. output characteristic, inclusive  $R_{CC'+EE'}$

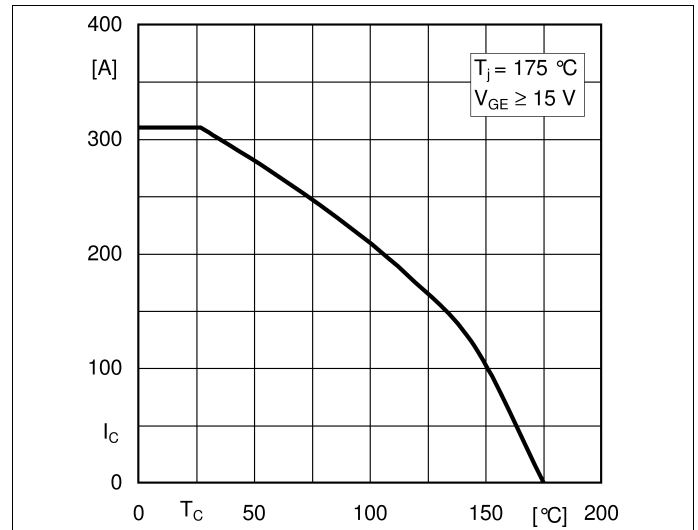


Fig. 2: Rated current vs. temperature  $I_C = f(T_C)$

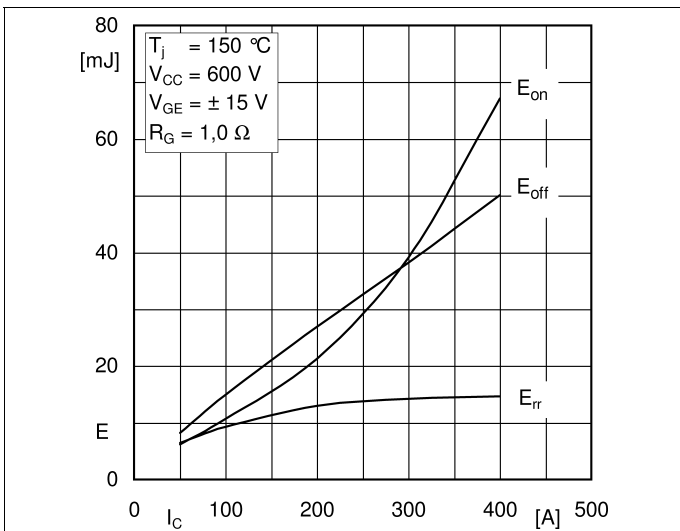


Fig. 3: Typ. turn-on /-off energy =  $f(I_C)$

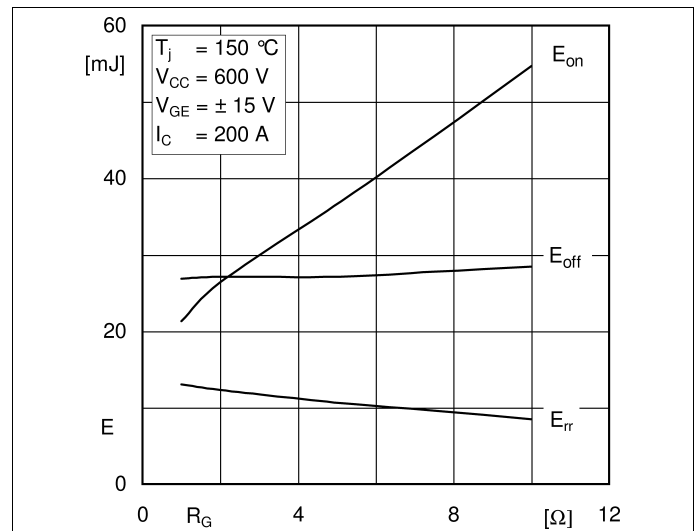


Fig. 4: Typ. turn-on /-off energy =  $f(R_G)$

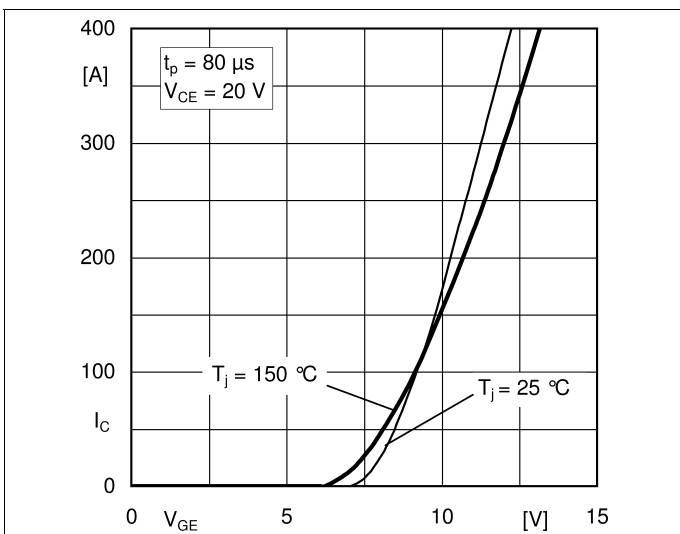


Fig. 5: Typ. transfer characteristic

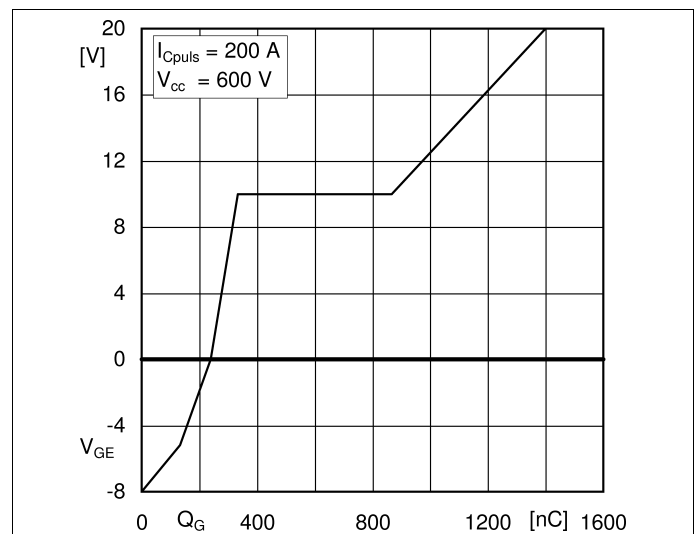


Fig. 6: Typ. gate charge characteristic

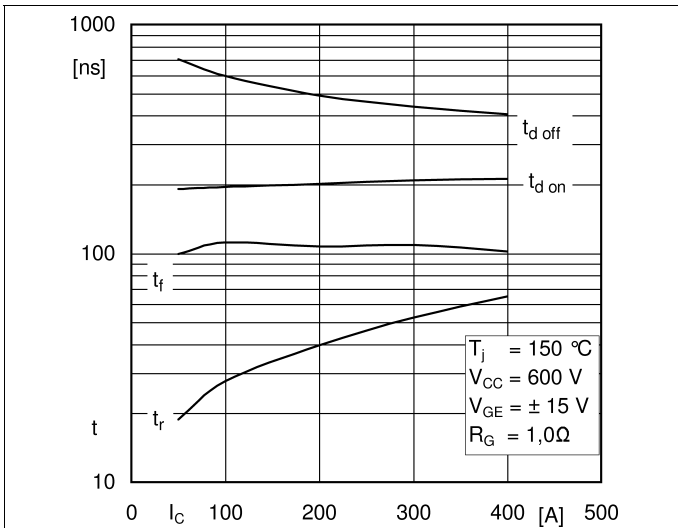


Fig. 7: Typ. switching times vs.  $I_C$

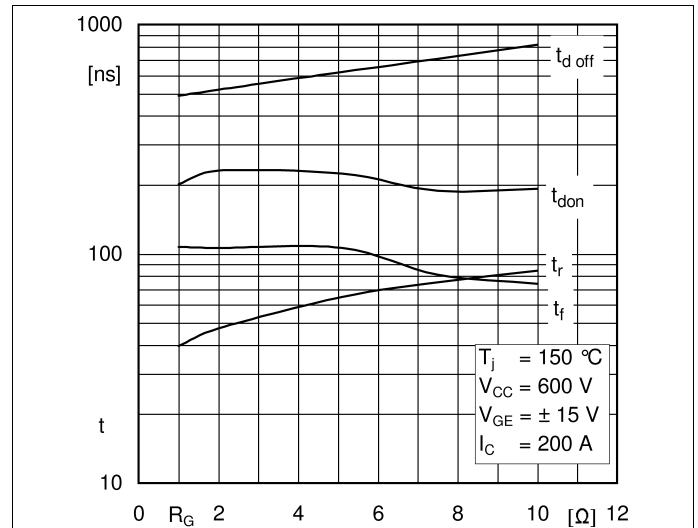


Fig. 8: Typ. switching times vs. gate resistor  $R_G$

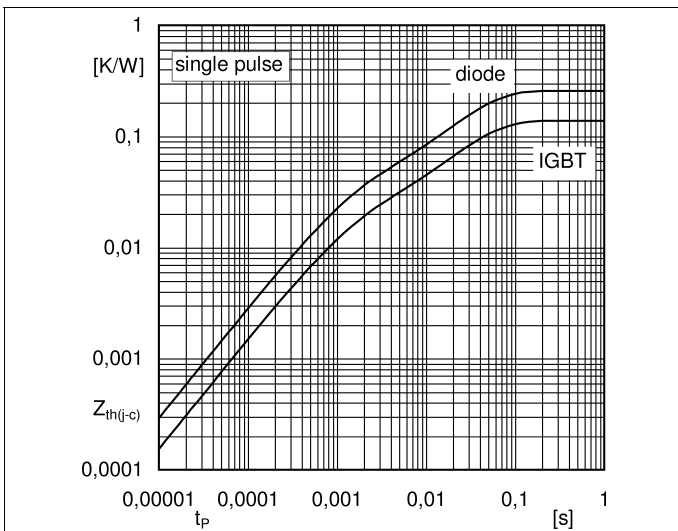


Fig. 9: Transient thermal impedance

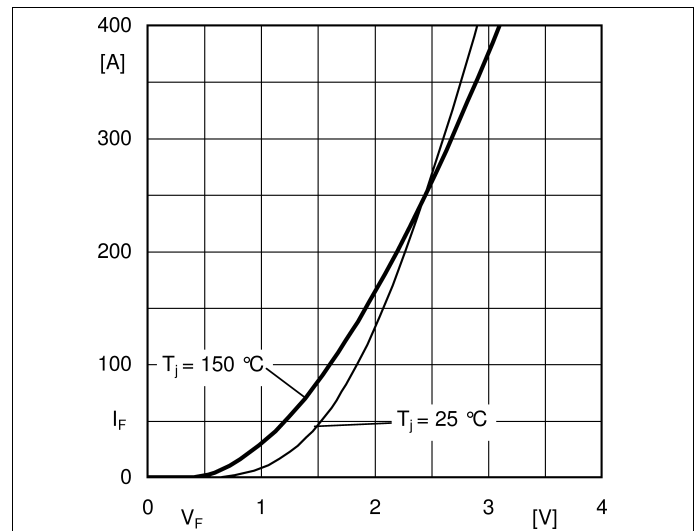


Fig. 10: Typ. CAL diode forward charact., incl.  $R_{CC+EE}$

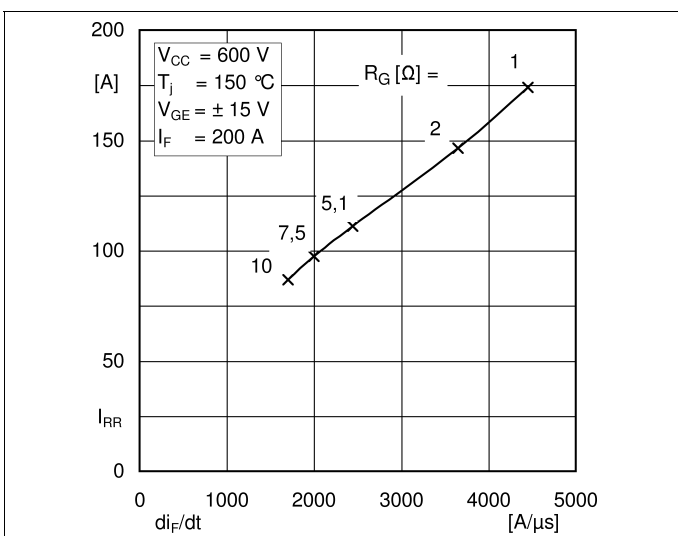


Fig. 11: CAL diode peak reverse recovery current

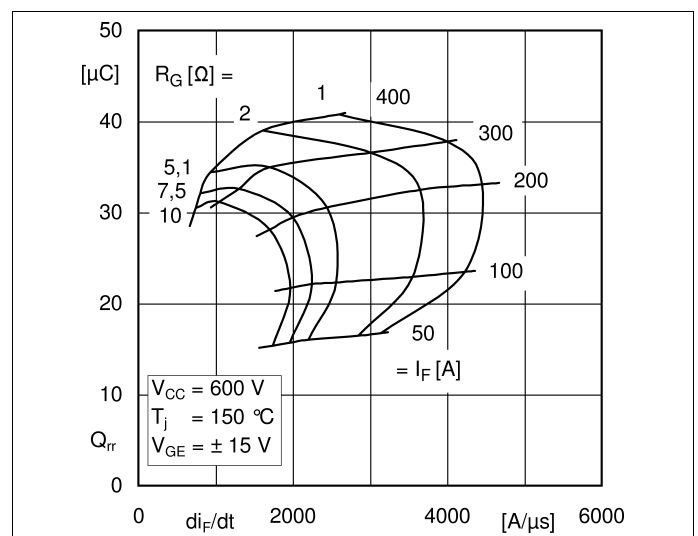
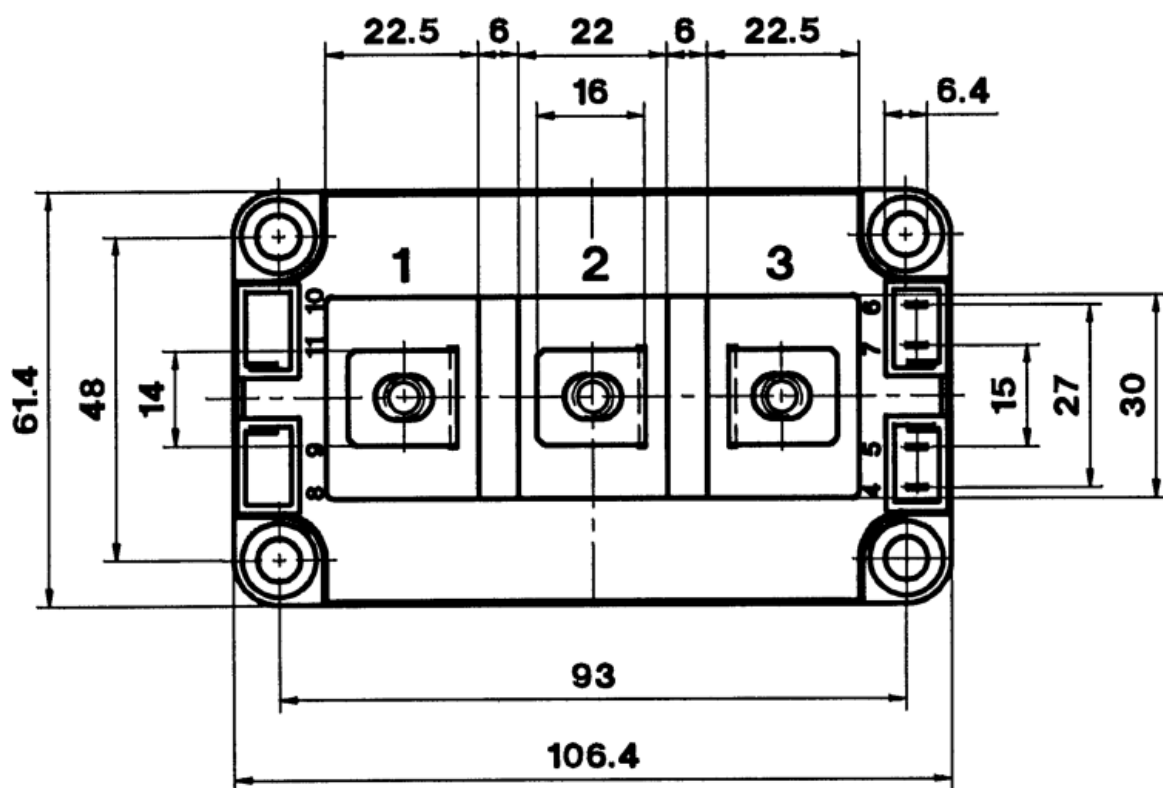
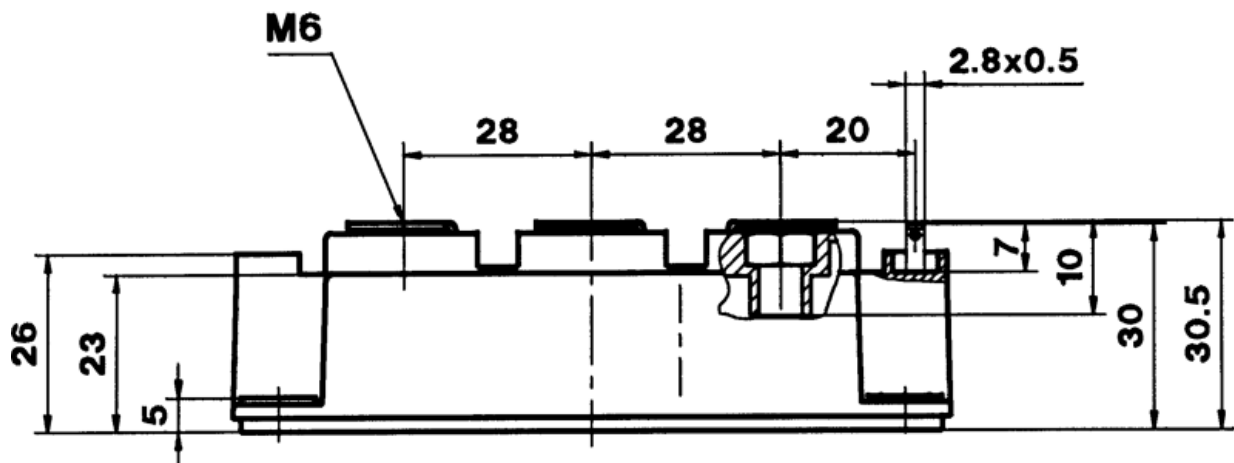
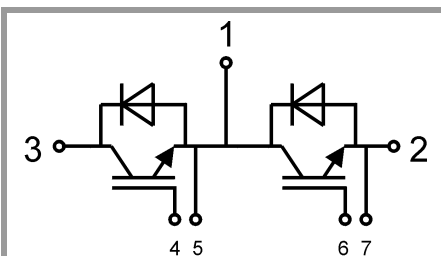


Fig. 12: Typ. CAL diode peak reverse recovery charge



SEMITRANS 3



GB

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [semikron](#) manufacturer:*

Other Similar products are found below :

[SKD 60/12](#) [SKKT 42B12 E](#) [SKM200GB12T4](#) [SKR 130/14](#) [SKCH 40/16](#) [SKKT 92/18E](#) [SKYPER 32 R](#) [SKKH 27/16E](#) [SKKD 380/16](#) [SKD 110/08](#) [SKD 62/12](#) [SKIIP 36NAB126V1 M20](#) [SKKD 162/20H4](#) [SKKD 380/08](#) [SKKH 72/20E H4](#) [SKKT 250/12E](#) [SKN71/02](#) [SKN 100/12](#) [SKN 100/14](#) [SKR 100/08](#) [SKIIP 24AC12T4V1 M20](#) [SKIIP 28AHB16V1 M20](#) [SKIIP 35NAB126V10 M20](#) [SKKH 570/16E](#) [SKKE 380/16](#) [SKR 130/18](#) [SKKD 26/14](#) [SKKT 570/18E](#) [SKN 130/14](#) [SKPC200-240](#) [SKPC100Z-440](#) [SK 100 WT 12](#) [SK 25 UT 12](#) [SKR70/04](#) [SKD35/16](#) [SKKT 42/08E](#) [SKCH 40/08](#) [SKD 62/18](#) [SKD 82/08](#) [SKIIP 23NAB126V1 M20](#) [SKKQ 1200/14E](#) [SKR 60F12](#) [SKR 100/04](#) [SKR 100/14](#) [SKIIP 37AC12T4V1 M20](#) [SKD 60/16](#) [SKD 62/08](#) [SKDT 60/12](#) [SKKT 106B16 E](#) [SKKD 60F17](#)